

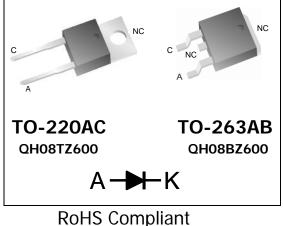
# QH08TZ600, QH08BZ600 Qspeed<sup>™</sup> Family

### 600 V, 8 A H-Series PFC Diode

### **Product Summary**

I <sub>F(AVG)</sub>	8	А
V <sub>RRM</sub>	600	V
Q <sub>RR</sub> (Typ at 125 °C)	25.5	nC
I <sub>RRM</sub> (Typ at 125 °C)	1.9	Α
Softness t <sub>B</sub> /t <sub>A</sub> (Typ at 125 °C)	0.75	

### **Pin Assignment**



Package uses Lead-free plating and Green mold compound. Halogen free per IEC 61249-2-21.

# **General Description**

This device has the lowest  $Q_{RR}$  of any 600 V silicon diode. Its recovery characteristics increase efficiency, reduce EMI and eliminate snubbers.

# **Applications**

- Power Factor Correction (PFC) boost diode
- Motor drive circuits
- DC-AC inverters

### **Features**

- Low  $Q_{RR}$ , low  $I_{RRM}$ , low  $t_{RR}$
- High dI<sub>F</sub>/dt capable (1000 A / μs)
- Soft recovery

### **Benefits**

- Increases efficiency
  - Eliminates need for snubber circuits
  - Reduces EMI filter component size & count
- Enables extremely fast switching

# Absolute Maximum Ratings

Absolute maximum ratings are the values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Symbol	Parameter	Conditions	Rating	Units
V <sub>RRM</sub>	Peak repetitive reverse voltage	T <sub>J</sub> = 25 °C	600	V
I <sub>F(AVG)</sub>	Average forward current	$T_{J} = 150 \ ^{\circ}C, \ T_{C} = 95 \ ^{\circ}C$	8	А
I <sub>FSM</sub>	Non-repetitive peak surge current	60 Hz, $\frac{1}{2}$ cycle, $T_c = 25$ °C	80	А
I <sub>FSM</sub>	Non-repetitive peak surge current	$\frac{1}{2}$ cycle of t=28 $\mu$ s Sinusoid, T <sub>C</sub> =25 °C	350	А
TJ	Operating junction temperature range		-55 to 150	°C
T <sub>STG</sub>	Storage temperature		-55 to 150	°C
	Lead soldering temperature	Leads at 1.6 mm from case, 10 sec	300	°C
VISOL	Isolation voltage (leads-to-tab)	AC, TO-220	2500	V
VISOL	Isolation voltage (leads-to-tab)	AC, TO-263	1500	V
P <sub>D</sub>	Power dissipation	$T_{C} = 25 \ ^{\circ}C$	44.6	W

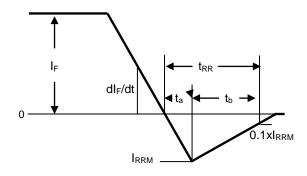
# Thermal Resistance

Symb	ol Resistance from:	Conditions	Rating	Units
$R_{\thetaJA}$	Junction to ambient	TO-220 (only)	62	°C/W
$R_{ ext{ ext{ ext{ ext{ ext{ ext{ ext{ ext$	Junction to case		2.8	°C/W

# Electrical Specifications at T<sub>J</sub>= 25 °C (unless otherwise specified)

Symbol	Parameter	Conditions		Min	Тур	Мах	Units
DC Chara	DC Characteristics						
	Reverse current	$V_R$ = 600 V, $T_J$ = 25 $^\circ$	C	-	-	250	μΑ
I <sub>R</sub>	Reverse current	$V_R = 600 V, T_J = 125$	°C	-	0.5	-	mA
V	Forward voltage	$I_F = 8 \text{ A},  T_J = 25 ^\circ\text{C}$		-	2.6	3.15	V
V <sub>F</sub>	Forward voltage	$I_F = 8 A, T_J = 150 \ ^{\circ}C$		-	2.23	-	V
CJ	Junction capacitance	V <sub>R</sub> = 10 V, 1 MHz		-	25	-	рF
Dynamic	Dynamic Characteristics						
t Dava	Doverse recovery time	$      dI/dt = 200 \text{ A}/\mu\text{s} \\ V_{\text{R}} = 400 \text{ V}, \text{ I}_{\text{F}} = 8 \text{ A} $	$T_J = 25 \ ^\circ C$	-	11.1	-	ns
۱ <sub>RR</sub>			$T_J = 125 \ ^\circ C$	-	19.5	-	ns
0	Doverse recovery charge	dI/dt = 200 A/µs	$T_J = 25 \ ^{\circ}C$	-	8.0	13.5	nC
Q <sub>RR</sub>	Reverse recovery charge	$V_R = 400 V$ , $I_F = 8 A$	$T_J = 125 \ ^\circ C$	-	25.5	-	nC
	Maximum reverse	dI/dt = 200 A/µs	$T_{ m J}=25$ °C	-	1.14	1.7	А
RRM	recovery current	$V_{R} = 400 V, I_{F} = 8 A$	$T_J = 125 \ ^\circ C$	-	1.9	-	А
6	Softness factor = $\frac{t_B}{t_A}$	$u/ut = 200 R/\mu 3$	$T_J = 25 \ ^{\circ}C$	-	0.7	-	
S Softr			$T_J = 125 \ ^\circ C$	-	0.75	-	

**Note to component engineers**: H-Series diodes employ Schottky technologies in their design and construction. Therefore, Component Engineers should plan their test setups to be similar to those for traditional Schottky test setups. (For additional details, see Application Note AN-300.)



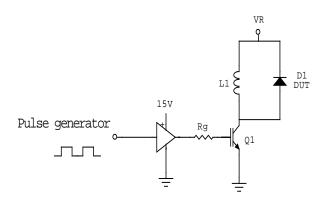
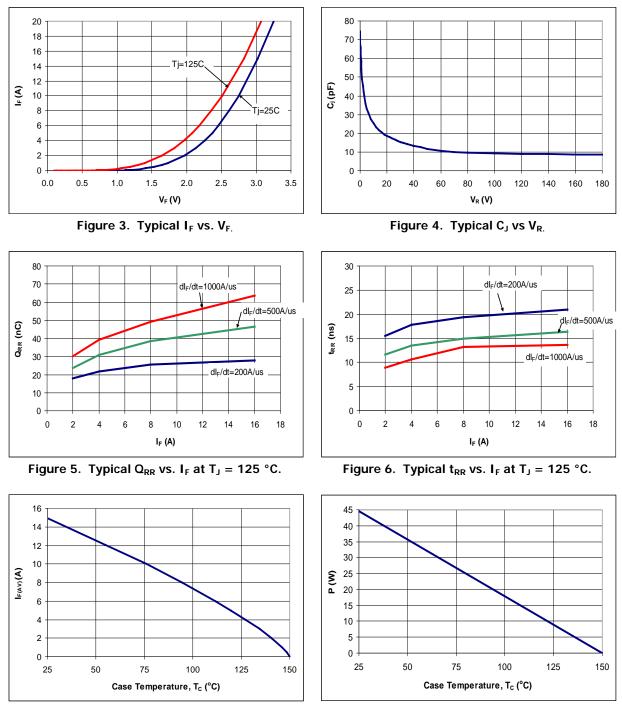


Figure 1. Reverse Recovery Definitions.

Figure 2. Reverse Recovery Test Circuit.







# Electrical Specifications at T<sub>J</sub>= 25 °C (unless otherwise specified)

Figure 7. DC Current Derating Curve.

Figure 8. Power Derating Curve.

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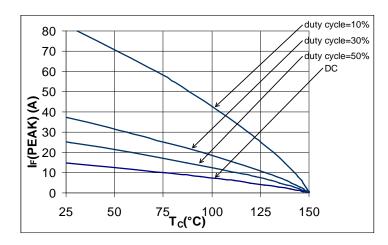


Figure 9.  $I_F$ (PEAK) vs.  $T_{C_7}$  f=70 kHz.

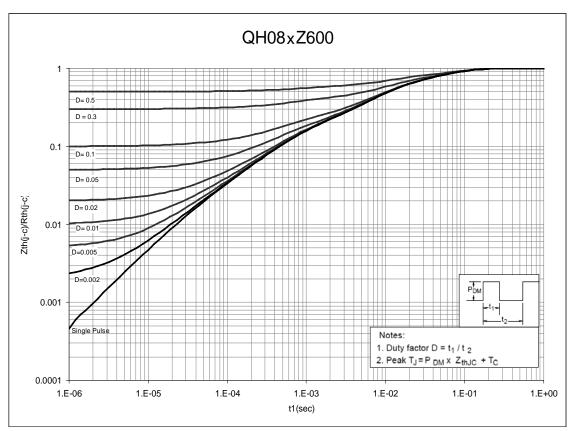


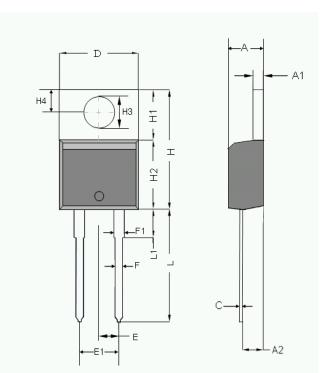
Figure 10. Normalized Maximum Transient Thermal Impedance.





# **Dimensional Outline Drawings**

TO-220AC



	Millimeters		
Dim	MIN	MAX	
А	4.32	4.70	
A1	1.14	1.40	
A2	2.03	2.79	
с	0.34	0.610	
D	9.65	10.67	
E	2.49	2.59	
E1	4.98	5.18	
F	0.508	1.016	
F1	1.14	1.78	
н	14.71	16.51	
H1	5.84	6.795	
H2	8.40	9.00	
H3	3.53	3.96	
H4	2.54	3.05	
L	12.70	14.22	
L1	-	6.35	

Mechanical Mounting Method	Maximum Torque / Pressure specification
Screw through hole in package tab	1 Newton Meter (nm) or 8.8 inch-pounds (lb-in)
Clamp against package body	12.3 kilogram-force per square centimeter (kgf/cm <sup>2</sup> ) or 175 lbf/in <sup>2</sup>

**Soldering time and temperature:** This product has been designed for use with high-temperature, lead-free solder. The component leads can be subjected to a maximum temperature of 300 °C, for up to 10 seconds. See Application Note AN-303, for more details.

# **Ordering Information**

Part Number	Package	Packing
QH08TZ600	TO-220AC	50 units/tube

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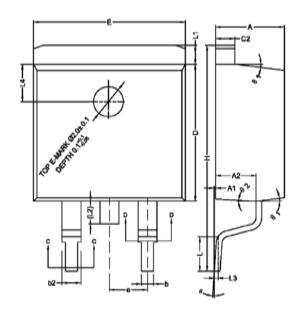




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# **Dimensional Outline Drawings**

TO-263AB



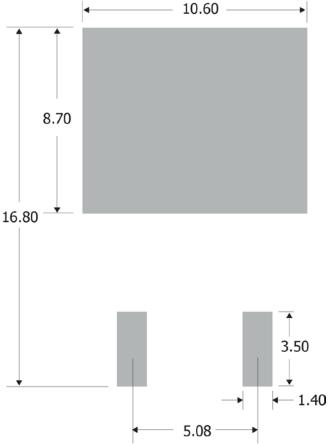
	Millimeters			
Dim	MIN	MAX		
А	4.40	4.70		
A1	0.00	0.25		
A2	2.59	2.79		
b	0.77	0.90		
b2	1.23	1.36		
c2	1.22	1.32		
D	9.05	9.25		
E	10.06	10.26		
е	2.54 BSC	2.54 BSC		
Н	14.70	15.50		
L	2.00	2.60		
L1	1.17	1.40		
L2	-	1.75		
L3	0.25 BSC	0.25 BSC		
L4	2.00 BSC	2.00 BSC		
Θ	0°	8°		
01	5°	9°		
02	1°	5°		





### **Footprint and Solder Pad Dimensions**





**Soldering time and temperature:** This product has been designed for use with high-temperature, lead-free solder. The component leads can be subjected to a maximum temperature of 300 °C, for up to 10 seconds. See Application Note AN-303, for more details.

# **Ordering Information**

Part Number	Package	Packing
QH08BZ600	TO-263AB	800 units/reel

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Revision	Notes	Date
1.0	Released by Qspeed	01/10
1.1	Converted to Power Integrations Document	01/11
1.2	Added QH08BZ600	02/13
1.3	Updated with new Brand Style. Added footprint and solder pad dimension for TO-263AB package.	11/15





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#### WORLD HEADQUARTERS

5245 Hellyer Avenue San Jose, CA 95138, USA. Main: +1-408-414-9200 Customer Service: Phone: +1-408-414-9665 Fax: +1-408-414-9765 e-mail: usasales@power.com

### CHINA (SHANGHAI)

Rm 2410, Charity Plaza, No. 88, North Caoxi Road, Shanghai, PRC 200030 Phone: +86-21-6354-6323 Fax: +86-21-6354-6325 e-mail:\_chinasales@power.com

#### CHINA (SHENZHEN)

17/F, Hivac Building, No. 2, Keji Nan 8th Road, Nanshan District, Shenzhen, China, 518057 Phone: +86-755-8672-8689 Fax: +86-755-8672-8690 e-mail: chinasales@power.com

### GERMANY

Lindwurmstrasse 114 80337, Munich Germany Phone: +49-895-527-39110 Fax: +49-895-527-39200 e-mail: eurosales@power.com

### INDIA

#1, 14<sup>th</sup> Main Road Vasanthanagar Bangalore-560052 India Phone: +91-80-4113-8020 Fax: +91-80-4113-8023 e-mail: indiasales@power.com

### ITALY

Via Milanese 20, 3<sup>rd</sup>. Fl. 20099 Sesto San Giovanni (MI) Italy Phone: +39-024-550-8701 Fax: +39-028-928-6009 e-mail: eurosales@power.com

### JAPAN

Kosei Dai-3 Building 2-12-11, Shin-Yokohama, Kohoku-ku, Yokohama-shi, Kanagawa 222-0033 Japan Phone: +81-45-471-1021 Fax: +81-45-471-3717 e-mail: japansales@power.com

### KOREA

RM 602, 6FL Korea City Air Terminal B/D, 159-6 Samsung-Dong, Kangnam-Gu, Seoul, 135-728 Korea Phone: +82-2-2016-6610 Fax: +82-2-2016-6630 e-mail: koreasales@power.com

### SINGAPORE

51 Newton Road, #19-01/05 Goldhill Plaza Singapore, 308900 Phone: +65-6358-2160 Fax: +65-6358-2015 e-mail: singaporesales@power.com

#### TAIWAN

5F, No. 318, Nei Hu Rd., Sec. 1 Nei Hu District Taipei 11493, Taiwan R.O.C. Phone: +886-2-2659-4570 Fax: +886-2-2659-4550 e-mail: taiwansales@power.com

#### UK

First Floor, Unit 15, Meadway Court, Rutherford Close, Stevenage, Herts. SG1 2EF United Kingdom Phone: +44 (0) 1252-730-141 Fax: +44 (0) 1252-727-689 e-mail: eurosales@power.com



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